



PROGRAMMABLE CONTROLLERS MELSEC iO F

MELSEC iQ-F FX5U CPU Module

Hardware Manual



This manual describes the part names, dimensions, installation, cabling and specifications for the product. This manual is extracted from MELSEC iQ-F FX5U User's Manual (Hardware). Refer to MELSEC iQ-F FX5U User's Manual (Hardware) for more details. Before use, read this manual and manuals of relevant products fully to acquire proficiency in the handling and operating the product. Make sure to learn all the product information, safety information, and precautions

And, store this manual in a safe place so that you can take it out and read it whenever necessary. Always forward it to the end user.

Registration: Ethernet is a trademark of Xerox Corporation. MODBUS® is a registered trademark of Schneider Electric SA. Phillips is a registered trademark of Phillips Screw Company. The company name and the product name to be described in this manual are the registered trademarks or trademarks of each company.

Effective March 2015

Specifications are subject to change without notice.

© 2014 MITSUBISHI ELECTRIC CORPORATION Safety Precaution (Read these precautions before use.)

This manual classifies the safety precautions into two categories:

	WARNING	and	CAUTION .	
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Indicates that incorrect handling may cause hazardous conditions, resulting in death or severe injury.
Indicates that incorrect handling may cause hazardous conditions, resulting in minor or moderate injury or property damage.

Depending on the circumstances, procedures indicated by ACAUTION may also cause severe injury.

It is important to follow all precautions for personal safety

STARTUP AND MAINTENANCE PRECAUTIONS

- Do not touch any terminal while the PLC's power is on. Doing so may cause electric shock or malfunctions.
- Before cleaning or retightening terminals, cut off all phases of the power supply externally. Failure to do so in the power ON status may cause electric shock. Before modifying the program in mid-operation, forcing output, running or stopping the PLC, read through this manual carefully, and ensure complete safety
- An operation error may damage the machinery or cause accidents Do not change the program in the PLC from two or more peripheral equipmen
- devices at the same time. (i.e. from an engineering tool and a GOT) Doing so may cause destruction or malfunction of the PLC program Use the battery for memory backup in conformance to the MELSEC iQ-F
- FX5U User's Manual (Hardware).
- Use the battery for the specified purpose only.
- Connect the battery correctly.
- Do not charge, disassemble, heat, put in fire, short-circuit, connect reversely, weld, swallow or burn the battery, or apply excessive force (vibration, impact, drop, etc.) to the battery.
- Do not store or use the battery at high temperatures or expose to direct sunlight. Do not expose to water, bring near fire or touch liquid leakage or other
- contents directly. Incorrect handling of the battery may cause excessive heat, bursting,
- ignition, liquid leakage or deformation, and lead to injury, fire or failures and malfunction of facilities and other equipment.

ACAUTION

Do not disassemble or modify the PLC.

STARTUP AND MAINTENANCE

DECAUTIONS

- Doing so may cause fire, equipment failures, or malfunctions. For repair, contact your local Mitsubishi Electric representative.
- Turn off the power to the PLC before connecting or disconnecting any extension cable

JY997D53401C

- Failure to do so may cause equipment failures or malfunctions.
- Turn off the power to the PLC before attaching or detaching the following devices Failure to do so may cause equipment failures or malfunctions. Peripheral devices, expansion board, and expansion adapter
- Extension modules hus conversion module and battery

DISPOSAL PRECAUTIONS ACAUTION

- · Please contact a certified electronic waste disposal company for the environmentally safe recycling and disposal of your device.
 - When disposing of batteries, separate them from other waste according t
 - local regulations. (For details on the Battery Directive in EU countries, refer to the MELSE iQ-F FX5U User's Manual (Hardware).)

TRANSPORTATION PRECAUTIONS

- · When transporting the PLC with the optional battery, turn on the PLC before shipment, confirm that the battery mode is set in PLC parameter and the BAT LED is OFF, and check the battery life.
- If the PLC is transported with the BAT LED ON or the battery exhausted the battery-backed data may be lost during transportation.
- The PLC is a precision instrument. During transportation, avoid impacts larger than those specified in the general specifications (Section 2.1) by using dedicated packaging boxes and shock-absorbing palettes. Failure to do so may cause failures in the PLC.
- After transportation, verify operation of the PLC and check for damage of the mounting part, etc.
- When transporting lithium batteries, follow required transportation regulations (For details on the regulated products, refer to the MELSEC iQ-F FX5L User's Manual (Hardware))

Associated manuals

How to obtain manuals For the necessary product manuals or documents, consult with your local Mitsubishi Electric representative.

Associated manuals

FX5U CPU module comes with this document (hardware manual). For a detailed explanation of the FX5U CPU module hardware and information on instructions for PLC programming and intelligent function module, refer to the relevant documents

Manual name	Manual No.	Description
MELSEC iQ-F FX5 User's Manual (Startup)	JY997D58201	Explains performance specifications, procedures before operation, and troubleshooting of the FX5 CPU module.
MELSEC iQ-F FX5U User's Manual (Hardware)	JY997D55301	Explains FX5U CPU module specification details for I/O, wiring, installation, and maintenance.
MELSEC iQ-F FX5 User's Manual (Serial Communication)	JY997D55901	Explains the N:N network, MELSEC Communication protocol, inverter communication and non-protocol communication.
MELSEC iQ-F FX5 User's Manual (MODBUS Communication)	JY997D56101	Explains the MODBUS serial communication.
MELSEC iQ-F FX5 User's Manual (Ethernet Communication)	JY997D56201	Functions for communication via built-in Ethernet port



Certification of UL, cUL standards

Please consult with Mitsubishi Electric for information on UL, cUL standard practices and the corresponding types of equipment

Compliance with EC directive (CE Marking)

This document does not guarantee that a mechanical system including this product will comply with the following standards. Compliance to EMC directive and LVD directive of the entire mechanical system should be checked by the user/manufacturer. For more details please contact the local Mitsubishi Electric sales site

Attention

- This product is designed for use in industrial applications Note
- · Authorized Representative in the European Community: Mitsubishi Electric Europe B.V.

Installation in Enclosure

Programmable controllers are open-type devices that must be installed and used within conductive control boxes. Please use the FX5U CPU module programmable controllers while installed in conductive shielded control boxes. Please secure the control box lid to the control box (for conduction). Installation within a control box greatly affects the safety of the system and aids in shielding noise from the programmable controller.

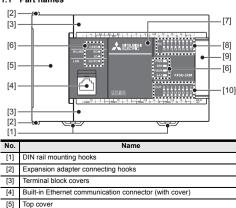
Check if the following product and items are included in the package:

		Included items	
	CPU module		
		Product	1 module
	FX5U-32M□, FX5U-64M□.	Dust proof protection sheet	1 sheet
FX5U-80MD		Manuals [Japanese /English]	1 manual
		Manuals [Chinese]	1 manual

	I/O module		
FX5-8ED,		Product	1 module
FX5-16ED	Dust proof protection sheet	1 sheet	
		Product	1 module
FX5-32ED	Dust proof protection sheet	1 sheet	
	Extension cable	1 cable	

1. Outline

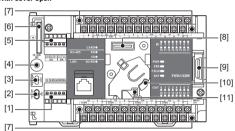
1.1 Part names



	No.		Name				
		Operation status display LEDs					
		PWR	Green	On while the PLC is powered.			
		ERR ^{*1}	Red	Lit/flashing when an error occurs.			
		P.RUN	Green	On while the PLC is running.			
		BAT	Red	Lit when the battery voltage drops.			
	[6]	CARD	Green	Lit when the SD memory card is inserted.			
		RD	Green	Lit when data is received through communication via built-in RS-485.			
		SD	Green	Lit when data is sent through communication via built-in RS-485.			
		SD/RD	Green	Lit when data is sent or received through communication via built-in Ethernet.			
	[7]	Expansion board connector cover					
	[8]	Input display LEDs (Green)					
	[9]	Extension connector cover					
	[10]	Output of	display Ll	EDs (Green)			

*1 When powered on in the factory default state. ERR LED starts flashing because there is no program. For details, refer to the following manual. → Refer to MELSEC iQ-F FX5U User's Manual (Hardware).

With cover open



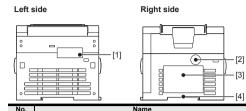
No.	Name				
[1]	Built-in RS-485 communication terminal block				
[2]	RS-485 terminal resister selector switch				
[3]	RUN/STOP/RESET switch				
[4]	SD memory card disable switch				
[5]	Built-in analog I/O terminal block				
[6]	SD memory card slot				
[7]	Terminal block mounting screws				
[8]	Expansion board connector				
[9]	Extension connector				
[10]	Battery holder				
[11]	Battery connector				

Gothaer Str. 8, 40880 Ratingen, Germany Caution for compliance with EC Directive

For other cautions, refer to the MELSEC iQ-F FX5U User's Manual (Hardware)

Incorporated Items

Included Items		
CPU module		
	Product	1
FX5U-32M□, FX5U-64M□	Dust proof protection sheet	



Expansion adapter connector cover [1]

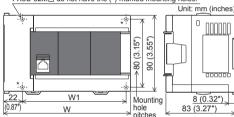
- [2] Genuine product certification label*1
- [3] Nameplate*

[4] DIN rail mounting groove

*1 Products that do not have the genuine product certification label or nameplate are not covered by the warranty.

1.2 External dimensions and weight

2-64.5-diam mounting holes (FX5U-32M□) 4-64.5-diam mounting holes (FX5U-64M□, FX5U-80M□) FX5U-32M□ do not have the (*)-marked mounting holes.



Model name	W: mm (inches)	W1:mm (inches) Mounting hole pitches	MASS (Weight): kg (lbs.)
FX5U-32MD	150 (5.91")	123 (4.85")	Approx. 0.65 (1.43 lbs)
FX5U-64M□	220 (8.67")	193 (7.60")	Approx. 1.0 (2.20 lbs)
FX5U-80MD	285 (11.23")	258 (10.16")	Approx. 1.2 (2.64 lbs)

2. Installation (general specifications)

As for installation of the I/O modules, expansion adapters and expansion boards, refer to MELSEC iQ-F FX5U User's Manual (Hardware).

INSTALL ATION PRECAUTIONS

- Use the product within the generic environment specifications described in section 2.1 of this manual Never use the product in areas with excessive dust, oily smoke
- conductive dusts, corrosive gas (salt air, Cl2, H2S, SO2 or NO2) flammable gas, vibration or impacts, or expose it to high temperature, condensation, or rain and wind,

If the product is used in such conditions, electric shock, fire, malfunctions deterioration or damage may occur

INSTALL ATION PRECAUTIONS

- · Do not touch the conductive parts of the product directly. Doing so may cause device failures or malfunctions.
- When drilling screw holes or wiring, make sure that cutting and wiring debris do not enter the ventilation slits of the PLC. Failure to do so may cause fire, equipment failures or malfunctions.
- For product supplied together with a dust proof sheet, the sheet should be affixed to the ventilation slits before installation and wiring work to block foreign objects such as cutting and wiring debris. However, when the installation work is completed, make sure to remove the sheet to provide adequate ventilation.

Failure to do so may cause fire, equipment failures or malfunctions

INSTALLATION PRECAUTIONS

- Install the product on a flat surface. If the mounting surface is rough, undu force will be applied to the PC board, thereby causing nonconformities.
- Install the product securely using a DIN rail or mounting screws. Connect the extension cables, peripheral device cables, input/output cables
- and battery connecting cable securely to their designated connectors. Loose connections may cause malfunctions.
- Turn off the power to the PLC before attaching or detaching the following devices Failure to do so may cause equipment failures or malfunctions.
- Peripheral devices, expansion board, and expansion adapter Extension modules, bus conversion module, and battery

2.1 Generic specifications					
ltem		Specification			
Operating ambient temperature*1	0 to 55 °C	C (32 to 13	1 ℉) ^{*2}		
Storage ambient temperature	-25 to 75	-25 to 75 ℃ (-13 to 167 °F)			
Operating ambient humidity	5 to 95%RH, non-condensing				
Storage ambient humidity	5 to 95%RH, non-condensing				
		Frequency (Hz)	Acceleration (m/s ²)	Half amplitude (mm)	Sweep count
Vibration resistance ^{*3*4}	Installed	5 to 8.4	_	1.75	10 times each
	on DIN rail	8.4 to 150	4.9	—	in X, Y, Z directions
		E 4+ 0 4			uncouolis

	Installed directly	5 to 8.4	_	3.5	(80 min in
		8.4 to 150	9.8		each direction)
Shock resistance*3		147 m/s ² Acceleration, Action time: 11 ms, 3 times by half-sine pulse in each direction X, Y, and Z			
Noise durability		y noise simulator of 1000 Vp-p noise voltage, 1 µs noise vidth and 30 to 100 Hz noise frequency			
Dielectric withstand voltage ^{*5}		1.5 kV AC for 1 minute or 500 V AC for 1 minute Between each terminal			
Insulation resistance ^{*5}	10 $M\Omega$ or higher by 500 VDC and ground terminal insulation resistance tester				terminal
Grounding	Class D grounding (Grounding resistance: 100 Ω or less) <common a="" allowed.="" electrical="" grounding="" heavy="" is="" not="" system="" with="">^{*6}</common>				
Working atmosphere	Free from corrosive or flammable gas and excessive conductive dusts				
Operating altitude*7	0 to 2000 m				
Installation location	Inside a control panel				

Overvoltage category*8	II or less
Pollution degree*9	2 or less
Equipment class	Class 2

- *1 The simultaneous ON ratio of available PLC inputs or outputs changes with respect to the ambient temperature, refer to MELSEC iQ-F FX5U User's Manual (Hardware).
- *2 For intelligent function modules, refer to the manual for each product. *3 The criterion is shown in IEC61131-2.
- *4 When the system has equipment which specification values are lower than above mentioned vibration resistance specification values, the vibration resistance specification of the whole system is corresponding to the lower specification.
- *5 Dielectric withstand voltage and insulation resistance are shown in the following table.

Terminal	Dielectric strength	Insulation resistance	
CPU modules, I/O modules			
Between power supply terminal (AC power) and ground terminal	1.5 kV AC for 1 minute	10 MΩ or higher by 500 VDC	
Between 24 V DC service power supply connected to input terminal (24 V DC) and ground terminal	500 V AC for 1 minute	insulation resistance tester	
Between output terminal (relay) and ground terminal	1.5 kV AC for 1 minute	10 MΩ or higher by 500 VDC	
Between output terminal (transistor) and ground terminal	500 V AC for 1 minute	insulation resistance tester	

Terminal	Dielectric strength	Insulation resistance			
Expansion boards, expansion adapter	Expansion boards, expansion adapters, intelligent function module				
Between terminal of expansion board and ground terminal	Not allowed	Not allowed			
Between terminal of expansion adapter and ground terminal	500 V AC for 1 minute	$10\ M\Omega$ or higher by 500 VDC insulation resistance tester			
Intelligent function module	Ea	ch manual			

For dielectric withstand voltage test and insulation resistance test of each

product, refer to the following manual → Refer to MELSEC iQ-F FX5U User's Manual (Hardware).

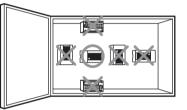
*6 For grounding, refer to Section 3.3.

- *7 The PLC cannot be used at a pressure higher than the atmospheric pressure to avoid damage
- *8 This indicates the section of the power supply to which the equipment is assumed to be connected between the public electrical power distribution network and the machinery within premises. Category II applies to equipment for which electrical power is supplied from fixed facilities. The surge voltage withstand level for up to the rated voltage of 300 V is 2500 V.
- *9 This index indicates the degree to which conductive material is generated in the environment in which the equipment is used. Pollution level 2 is when only non-conductive pollution occurs. Temporary conductivity caused by condensation must be expected occasionally.

2.2 Installation location

Install the PLC in an environment conforming to the generic specifications (Section 2.1), installation precautions and notes.

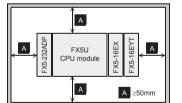
Installation location in enclosure



Space in enclosure

Extension devices can be connected on the left and right sides of the CPU module

If you intend to add extension devices in the future, keep necessary spaces on the left and right sides



2.2.1 Affixing the dust proof sheet

The dust proof sheet should be affixed to the ventilation port before beginning the installation and wiring work

→ For the affixing procedure, refer to the instructions on the dust proof sheet.

Be sure to remove the dust proof sheet when the installation and wiring work is completed

2.3 Procedures for installing to and detaching from DIN rail The products can be installed on a DIN46277 rail [35 mm (1.38") wide]. This

section explains the installations of the CPU modules.

2.3.1 Installation

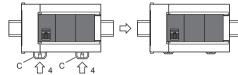
1) Connect the expansion boards and expansion adapters to the CPU module. 2) Push out all DIN rail mounting hooks (below fig. A)



3) Fit the upper edge of the DIN rail mounting groove (right fig. B) onto the DIN rail.



4) Lock the DIN rail mounting hooks (below fig. C) while pressing the PLC against the DIN rail



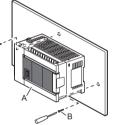
2.4 Procedures for installing directly (with M4 screws) The product can be installed directly on the panel (with screws). This section explains the installation of the CPU modules.

2.4.1 Mounting hole pitches Refer to the External Dimensions (Section 1.2) for the product's mounting hole

pitch information 2.4.2 Installation The FX5U-32M□ is used as the CPU

module in this example 1) Make mounting holes in the

mounting surface referring to the B external dimensions diagram. 2) Fit the CPU module (right fig. A) based on the holes, and secure it with M4 screws (right fig. B). (In the case of FX5U-64MD/80MD, there are four screw holes)



3. Specifications and examples of external wiring

As for the details of the power supply wiring and input/output wiring, refer to MELSEC iQ-F FX5U User's Manual (Hardware).

DESIGN PRECAUTIONS / WARNING

 Make sure to set up the following safety circuits outside the PLC to ensure safe system operation even during external power supply problems or PLC failure

- Otherwise, malfunctions may cause serious accidents.
- Most importantly, set up the following: an emergency stop circuit, a
 protection circuit, an interlock circuit for opposite movements (such as forward vs. reverse rotation), and an interlock circuit to prevent damage to the equipment at the upper and lower positioning limits.
- Note that when the CPU module detects an error, such as a watchdog timer error, during self-diagnosis, all outputs are turned off. Also, when an error that cannot be detected by the CPU module occurs in an input/ output control block, output control may be disabled. External circuits and mechanisms should be designed to ensure safe
- machine operation in such a case. Note that the output current of the 24V DC service power supply varies
- depending on the model and the absence/presence of extension modules. If an overload occurs, the voltage automatically drops, inputs
- in the PLC are disabled, and all outputs are turned off External circuits and mechanisms should be designed to ensure safe machine operation in such a case.
- Note that when an error occurs in a relay or transistor of an output circuit, the output might stay on or off.
- For output signals that may lead to serious accidents, external circuits and mechanisms should be designed to ensure safe machine operation
- Construct an interlock circuit in the program so that the whole system always operates on the safe side before executing control (for data change) of the PLC in operation. Read the manual thoroughly and sufficiently ensure complete safety before executing other controls (for program change, parameter change forced output and operation status change) of the PLC in operation. Otherwise, improper operation may damage machines or cause accidents.

DESIGN PRECAUTIONS

Simultaneously turn on and off the power supplies of the CPU module and extension modules

WIRING PRECAUTIONS **WARNING**

· Make sure to cut off all phases of the power supply externally before attempting installation or wiring work.

- Failure to do so may cause electric shock or damage to the product. Make sure to attach the terminal cover, provided as an accessory, before turning on the power or initiating operation after installation or wiring work Failure to do so may cause electric shock.
- The temperature rating of the cable should be 80°C or more.
- Make sure to wire the screw terminal block in accordance with the following precautions.
- Failure to do so may cause electric shock, equipment failures, a shortcircuit, wire breakage, malfunctions, or damage to the product. - Wire terminals should follow the dimensions described in the manual.
- Tightening torque should follow the specifications in the manual.
- Tighten the screws using a Phillips-head screwdriver No.2 (shaft diameter 6 mm (0.24") or less). Make sure that the screwdriver does not touch the partition part of the terminal block.
- Make sure to wire the terminal block (European type) in accordance with the following precautions.

Failure to do so may cause electric shock, equipment failures, a shortcircuit, wire breakage, malfunctions, or damage to the product.

- Wire terminals should follow the dimensions described in the manual. - Tightening torque should follow the specifications in the manual.
- Twist the ends of stranded wires and make sure that there are no loose wires.
- Do not solder-plate the electric wire ends.
- Do not connect more than the specified number of wires or electric wires of unspecified size.
- Affix the electric wires so that neither the terminal block nor the connected parts are directly stressed.

WIRING PRECAUTIONS

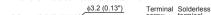
- Perform class D grounding (grounding resistance: 100 Ω or less) of the grounding terminal on the CPU module and extension modules with a wire 2 mm² or thicker. Do not use common grounding with heavy electrical systems (refer to section 3.3).
- Connect the power supply wiring to the dedicated terminals described in this manual.
- If an AC power supply is connected to a DC input/output terminal or DC power supply terminal, the PLC will burn out.
- Do not wire vacant terminals externally
- Doing so may damage the product.
- Make sure to observe the following precautions in order to prevent any damage to the machinery or accidents due to malfunction of the PLC caused by abnormal data written to the PLC due to the effects of noise.
- Do not bundle the power line, control line and communication cables together with or lay them close to the main circuit, high-voltage line, load line or power line. As a guideline, lay the power line, control line and communication cables at least 100 mm (3.94") away from the main circuit, high-voltage line, load line or power line.
- Ground the shield of the shielded wire or shielded cable at one point on the PLC. However, do not use common grounding with heavy electrical systems
- Ground the shield of the analog input/output cable at one point on the signal receiving side
- However, do not use common grounding with heavy electrical systems

Cable end treatment and tightening torque

3.1.1 Screw type terminal block

For the terminals of FX5U CPU module and I/O module, M3 screws are used. The electric wire ends should be treated as shown below. Tighten the screws to a torque of 0.5 to 0.8 N·m. Do not tighten terminal screws with a torque outside the above-mentioned range.

Failure to do so may cause equipment failures or malfunctions. · When one wire is connected to one terminal





<Reference>

Terminal Manufacturer	Type No.	Certification	Pressure Bonding Tool	
JST Mfg. Co., Ltd.	FV1.25-B3A	UL Listed	YA-1	
331 Wilg. 60., Etd.	FV2-MS3	OL LISIEU	(JST Mfg. Co., Ltd.)	

6.2 mm (0.24") or less	<u>∳3.2 (0.13")</u> •	Terminal Solderless screw terminal
->	6.3 mm (0.25") ← or more ∳3.2 (0.13")	léż
6.2 mm (0.24")	6.3 mm (0.25")	Terminal

<Reference>

Terminal Manufacturer	Type No.	Certification	Pressure Bonding Tool
JST Mfg. Co., Ltd.	FV1.25-B3A	UL Listed	YA-1 (JST Mfg. Co., Ltd.)

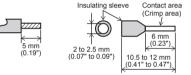
European type te 1) Wire size

When two wires are connected to one terminal

1) 1110 3120		
No. of wire	W	/ire size
per terminal	Solid wire/Stranded wire	Ferrules with insulating sleeve
1	AWG24 to 20	AWG24 to 20
2	AWG24	

2) Treatment of wire ends

Strip the coating of strand wire and twist the cable core before connecting it, or strip the coating of single wire before connecting it. An alternative connection is to use a ferrule with insulating sleeve



Manufacturer	Model	Caulking tool
Phoenix Contact GmbH & Co. KG	AI 0.5-6WH	CRIMPFOX 6

eve, choose a wire with proper cable sheath referring to the above outside dimensions, otherwise the wire cannot be inserted easily

Do not tighten terminal screws exceeding with a torque outside the abovementioned range

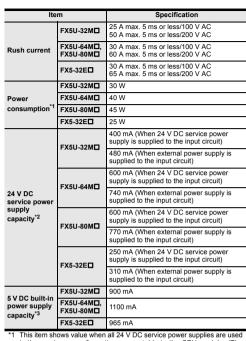
Tool For tightening the terminal, use a commercially available small screwdriver having a straight form that is not widened toward the end as shown right.

Note:

If the diameter of screwdriver grip is too small, tightening torque may not be achieved. To achieve the appropriate tightening torque shown in the table above, use the following screwdriver or appropriate replacement (grip diameter: approximately 25 mm (0.98"))

Phoenix Contact GmbH & Co. KG SZS 0.4×2.5

Ra All rar Fre All po Po



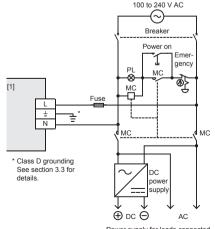
in the maximum configuration connectable to the CPU module. (The current of the input circuit is included.)

- *2 When I/O modules are connected, they consume current from the 24 V DC service power
- *3 Power is supplied to I/O modules, intelligent function modules, expansion adapters and expansion hoards
 - The following manual shows further information → Refer to MELSEC iQ-F FX5U User's Manual (Hardware).

3.2.2 Example of external wiring

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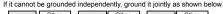
100 to 240 V AC power is supplied to the CPU module and FX5-32ED. For the details of wiring work, refer to Section 3.1.

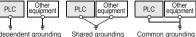


Power supply for loads connected [1]: CPU module, FX5-32ED to CPU module output terminals

3.3 Grounding

- Ground the PLC as stated below
- Perform class D grounding. (Grounding resistance: 100 Ω or less) · Ground the PLC independently if possible.





Independent grounding (Best condition) (Good condition) (Not allowed)

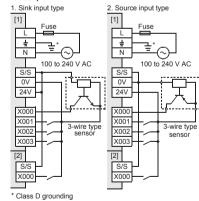
 Use ground wires thicker than AWG14 (2 mm²) · Position the grounding point as close to the PLC as possible to decrease the length of the ground wire.

3.4 Input specifications and external wiring

3.4.1 Input specifications (24 V DC input type)

	Item		Specification
Input signal voltage			24 V DC +20%, -15%
CPU		X000 to X017	4.3 kΩ
Input impedance	module	X020 or more	5.6 kΩ
Inpoduitoo	FX5 I/O	module	5.6 kΩ
	CPU	X000 to X017	5.3 mA/24 V DC
Input signal current	module	X020 or more	4 mA/24 V DC
ourroint	FX5 I/O	module	4 mA/24 V DC
ON input	CPU	X000 to X017	3.5 mA or more
sensitivity		X020 or more	3.0 mA or more
current	FX5 I/O	module	3.0 mA or more
OFF input se	ensitivity	current	1.5 mA or less
Input respor	ise time		Refer to MELSEC iQ-F FX5U User's Manual (Hardware)
Input signal form Sink input		Sink input	No-voltage contact input NPN open collector transistor
		Source input	No-voltage contact input PNP open collector transistor
Input operation display		y	LED on panel turns on when inpu

3.4.2 Examples of input wiring (when 24 V DC service power supply is used)



See section 3.3 for details. [1]: CPU module, FX5-32ED [2]: Input module

Manufacturer	Model
Phoenix Contact GmbH & Co. KG	AI 0.5-6W
When using a wire ferrule with an ir	nsulating sle

Tighten the screws to a torque of 0.22 to 0.25 N·m.

Failure to do so may cause equipment failures or malfunctions.

With straight tip 0.4 mn (0.01") (0.09")

Manufacturer Model names

3.2 Power supply specifications and external wiring

3.2.1 Power supply specifications [CPU module, FX5-32ED]

Item		Specification	
ated voltage		100 to 240 V AC	
lowable supply voltage nge		85 to 264 V AC	
equency rating		50/60 Hz	
llowable instantaneous ower failure time		Operation can be continued upon occurrence of instantaneous power failure for 10 ms or less.	
ower fuse	FX5U-32MD, FX5-32ED	250 V 3.15 A Time-lag Fuse	
Jwei luse	FX5U-64M□, FX5U-80M□	250 V 5 A Time-lag Fuse	



3.5 Relay output specifications and external wiring 3.5.1 Relay output specifications

	ltem	Specification	
External power supply		30 V DC or less 240 V AC or less ("250 V AC or less" if not a CE, UL, cUL compliant item)	
Max. load		2 A/point ^{*1}	
Min. load		5 V DC, 2 mA (reference value)	
Open circui	t leakage current	—	
Response time OFF↔ON		Approx. 10 ms	
Output oper	ation display	LED on panel turns on when output.	

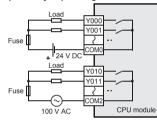
*1 The total load current of resistance loads per common terminal should be the following value.

- 4 output points/common terminal: 8 A or less

- 8 output points/common terminal: 8 A or less As for the number of outputs per common terminal, refer to Chapter 4 and the following manual.

→ Refer to MELSEC iQ-F FX5U User's Manual (Hardware).

3.5.2 Example of relay output wiring



3.6 Transistor output specifications and external wiring 3.6.1 Transistor output specifications

		Specification		
Output FX5U-DMT/ES, FX5-DEYT/ES, FX5-32ET/ES			Transistor (Sink)	
form	m FX5U-DMT/ESS, FX5-DEYT/ESS, FX5-32ET/ESS		Transistor (Source)	
External po	wer supp	ly		5 to 30 V DC
Max. load				0.5 A/point*1
Min. load			-	
Open circui	t leakage	current		0.1 mA or less/30 V DC
ON voltage		CPU	Y000 to Y003	1.0 V or less
		module	Y004 or more	1.5 V or less
		I/O modu	le	1.5 V or less
		CPU	Y000 to Y003	2.5 µs or less/10 mA or more (5 to 24 V DC)
Response time	OFF↔ ON	module	Y004 or more	0.2 ms or less/200 mA or more (at 24 V DC)
		I/O modu	le	0.2 ms or less/200 mA or more (at 24 V DC)
Output operation display			LED on panel turns on when output.	

*1 The total load current of resistance loads per common terminal should be the following value.

- 4 output point/common terminal: 0.8 A or less

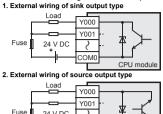
- 8 output point/common terminal: 1.6 A or less

As for the number of outputs per common terminal, refer to Chapter 4 and the following manual.

→ Refer to MELSEC iQ-F FX5U User's Manual (Hardware).

3.6.2 External wiring of transistor output

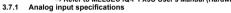
24 V DC



+\/0

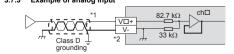
CPU module 3.7 Built-in analog input/output specifications and external wiring

As for the details on the built-in analog input/output specifications and external wiring, refer to the following manual. → Refer to MELSEC iQ-F FX5U User's Manual (Hardware).



Item		Specifications		
Analog input points		2 points (2 channels)		
Analog input		0 to 10 V DC (Input resistance: 115.7 kΩ)		
Digital output		12 bit unsigned binary		
Device allocation		SD6020 (Input data of ch1) SD6060 (Input data of ch2)		
Input	Digital output value	0 to 4000		
characteristics	Maximum resolution	2.5 mV		
Accuracy (Accuracy in respect to maximum digital output value)		When ambient temperature is $25 \pm 5^{\circ}$ C (77 $\pm 41^{\circ}$ F) Within $\pm 0.5\%$ ($\pm 20 \text{ digit}$) ^{*1} When ambient temperature is 0 to 55° C (32 to 131° F) Within $\pm 1.0\%$ ($\pm 40 \text{ digit}$) ^{*1}		
Absolute maxin	num input	-0.5 V, +15 V		
Insulation method		Inside the PLC and the analog input circuit are not insulated. Between input terminals (channels) is not insulated.		
Occupied points		0 point (Dose not occupy of input and output points of the PLC.)		
*1 Digit indicates a digital value. 3.7.2 Analog output specific		ations		
Item				
Ite	m	Specifications		
Ite Analog output p		Specifications 1 points (1 channels)		
Analog output p		1 points (1 channels)		
Analog output p	points	1 points (1 channels) 12 bit unsigned binary		
Analog output p Digital input Analog output Device allocatio Output	points	1 points (1 channels) 12 bit unsigned binary 0 to 10 V DC (Input resistance: 2 k to 1 MΩ)		
Analog output p Digital input Analog output Device allocatio	ooints on Digital input	1 points (1 channels) 12 bit unsigned binary 0 to 10 V DC (Input resistance: 2 k to 1 MΩ) SD6180 (Output setting data of ch1)		
Analog output p Digital input Analog output Device allocatio Output	Digital input Value Maximum resolution	1 points (1 channels) 12 bit unsigned binary 0 to 10 V DC (Input resistance: 2 k to 1 MΩ) SD6180 (Output setting data of ch1) 0 to 4000		
Analog output p Digital input Analog output Device allocatio Output characteristics Accuracy (Accur respect to maxi	n Digital input value Maximum resolution rracy in mum analog	1 points (1 channels) 12 bit unsigned binary 0 to 10 V DC (Input resistance: 2 k to 1 MΩ) SD6180 (Output setting data of ch1) 0 to 4000 2.5 mV When ambient temperature is 25 ±5°C (77 ±41°F) Within ±0.5% (±20 digit)*1 When ambient temperature is 0 to 55°C		

*1 Digit indicates a digital value. 3.7.3 Example of analog input

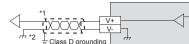


V□+, ch□: □ represents the channel number *1 Use 2-core shielded twisted pair cable for the analog input lines, and separate the analog input lines from other power lines or inductive lines.



*2 Make sure to short-circuit the "VD+" and "V-" terminals when channel is not used.

3.7.4 Example of analog output



*1 Use 2-core shielded twisted pair cable for the analog output lines, and separate the analog output lines from other power lines or inductive lines.

*2 Ground the shielded wire at one point on the signal receiving side.

3.7.5 Terminal block layouts

The terminals of the built-in analog input/output are arranged as follows:

		Signal	Application
		V1+	Channel 1 analog input (+)
0000	Analog	V2+	Channel 2 analog input (+)
V1+ V2+ V- V+	V-	V-	Analog input (-)*1
Analog Analog	g Analog	V+	Analog output (+)
input outp	ut output	V-	Analog output (-)*1

*1 The V- terminals are connected internally.

3.8 Built-in Ethernet communication specifications and external wiring

As for the details on the built-in Ethernet communication specifications and external wiring, refer to the following manual.

→ Refer to MELSEC iQ-F FX5 User's Manual (Ethernet Communication) . ..

Item		Specification		
Data transmission speed		100/10 Mbps		
Communication mode		Full-duplex (FDX)/Half-duplex (HDX)		
Interface		RJ45 connector		
Transmission method		Base band		
Maximum segment le	ength	100 m		
Cascade connection	100BASE-TX	Cascade connection max. 2 stages*1		
	10BASE-T	Cascade connection max. 4 stages ^{*1}		
Protocol type		MELSOFT connection, SLMP (3E frames) Socket communication, Predefined protocol support		
Number of simultaneously open connections allowed		Total of 8 for socket communication, MELSOFT connection, SLMP, and Predefined protocol support		
Insulation method		Pulse transformer		

Contact the manufacturer of the switching hub for the number of connectable stages when using a switching hub

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For the wiring, refer to the following manual. → Refer to MELSEC iQ-F FX5 User's Manual (Ethernet Communication). 3.8.3 Pin Configuration

The connector of the built in Ethernet communication are arranged as follows:

The connector of the built-in Ethemet communication are analiged as follows.					
		Pin No.	Signal	Contents	
· · · · · · · · · · · · · · · · · · ·		1	TXD+	Transmit data (+)	
		2	TXD-	Transmit data (-)	
	_	3	RXD+	Receive data (+)	
8 1		4	Not used		
		5	Not used		
		6	RXD-	Receive data (-)	
		7	Not used		
		8	Not used		
Applicable cable					
10BASE-T	Cable conforming to Ethernet standard practice: Category 3 or higher (STP cable)				
100BASE-TX	Cable conforming to Ethernet standard practice: Category 5 or higher (STP cable)				

A straight cable is used. A cross cable can also be used when using direct connection (simple connection) between a personal computer and the FX5U CPU module.

3.9 Built-in RS-485 communication specifications and external wiring

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Item	Specification
Transmission standard	In conformance to RS-485/RS-422
Data transmission speed	Max. 115.2 kbps
Communication method	Full-duplex/Half-duplex
Maximum total extension distance	50 m
Protocol type	MELSOFT connection, MELSEC Communication protocol (3C/4C frames), Non-protocol communication, MODBUS RTU, Inverter communication, N:N network, Predefined protoco support
Insulation method	No insulation between the PLC.
Terminal resistors	Built-in (OPEN/110 Ω/330 Ω)
Connection method	European terminal block

3.9.2 Wiring

For the wiring, refer to the following manual.

→ Refer to MELSEC iQ-F FX5 User's Manual (Serial Communication) → Refer to MELSEC iQ-F FX5 User's Manual (MODBUS Communication). 3.9.3 Terminal block layouts

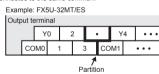
The terminals of the built-in RS-485 communication are arranged as follows:

	Signal name	Function
SG SDB SDA RDB RDA	RDA	Receive data
99999	RDB	Receive uala
	SDA	Send data
	SDB	Send data
	SG	Signal ground

4. Terminal block lavouts

For details on the terminal block layout, refer to the following manual. → Refer to MELSEC iQ-F FX5U User's Manual (Hardware).

Interpretation of partition The partition of the output terminals (see following figure) indicates the range of the output connected to the same common.



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20 digit)*1			2
ture is 0 to 55℃ .0% (±40 digit)*1			3
analog output		II	4
			5
y any input and	8	1	6
<i>.</i> .)	0		7
			8